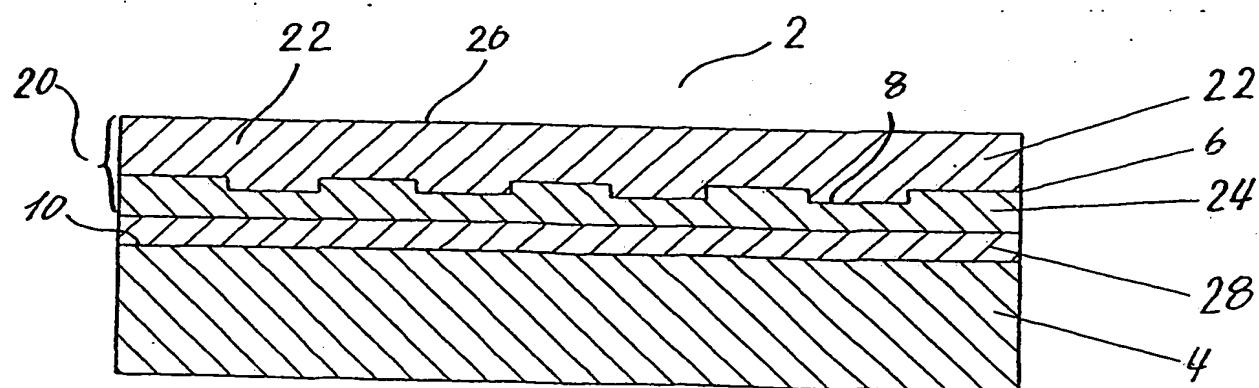
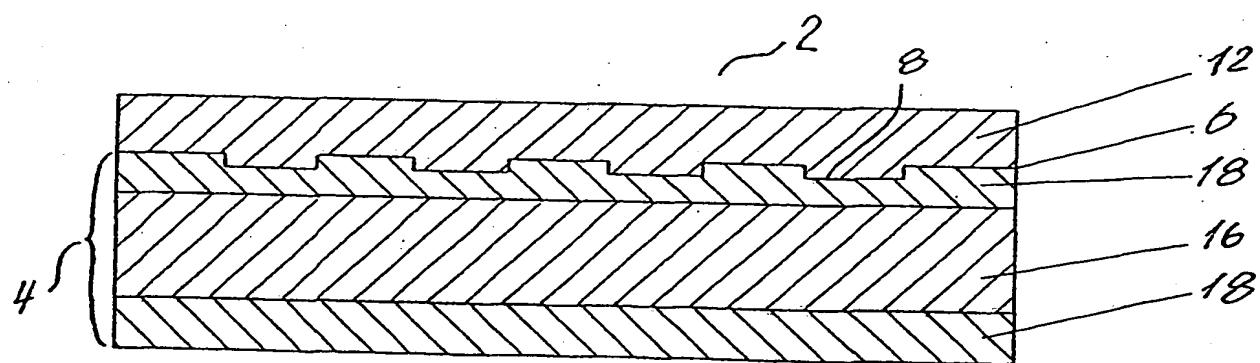
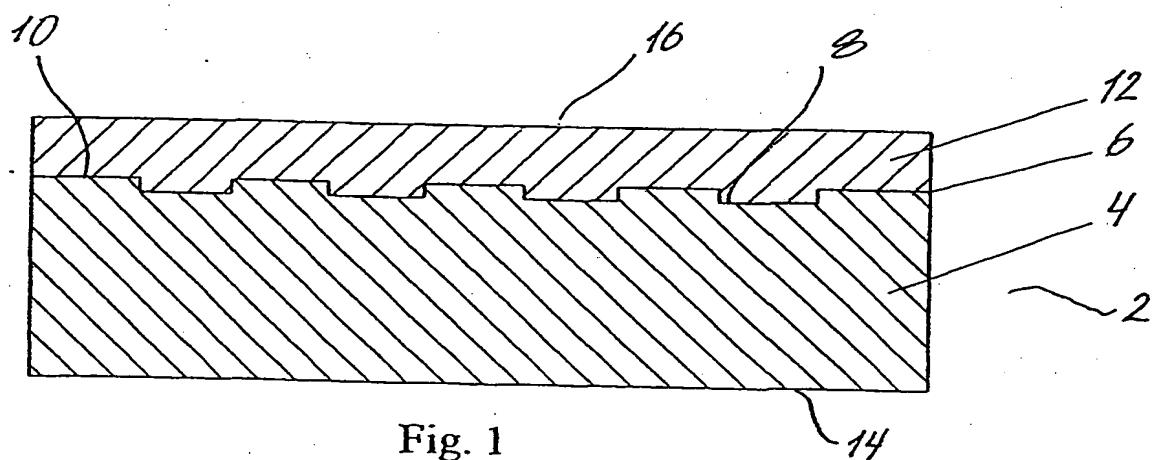


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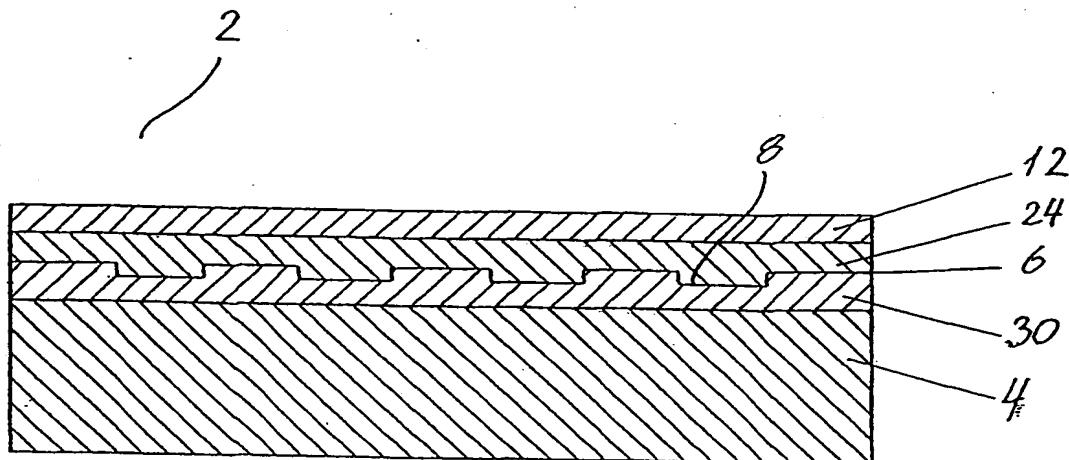


Fig. 4

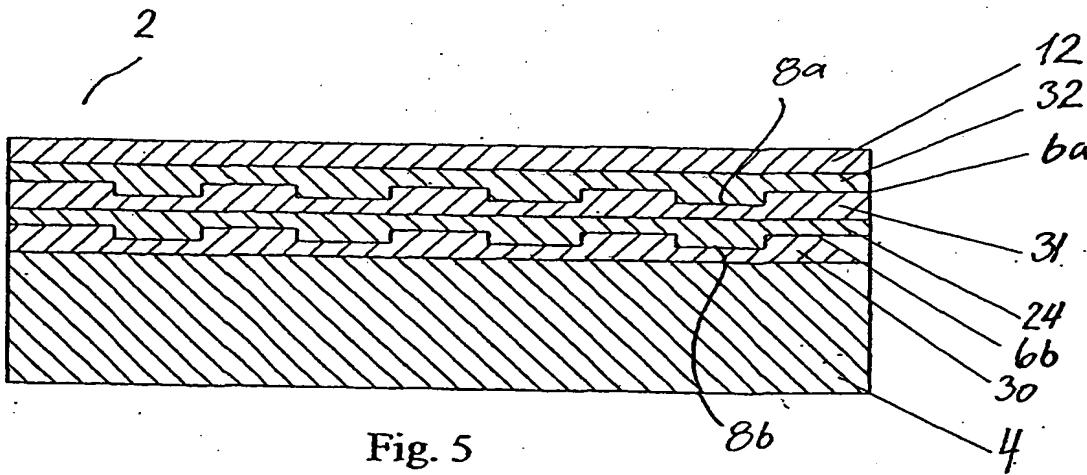


Fig. 5

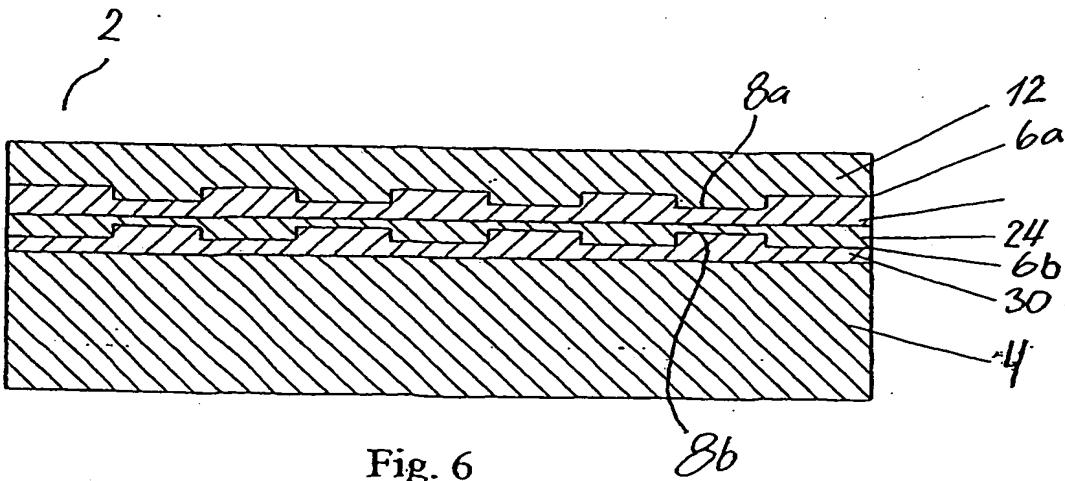


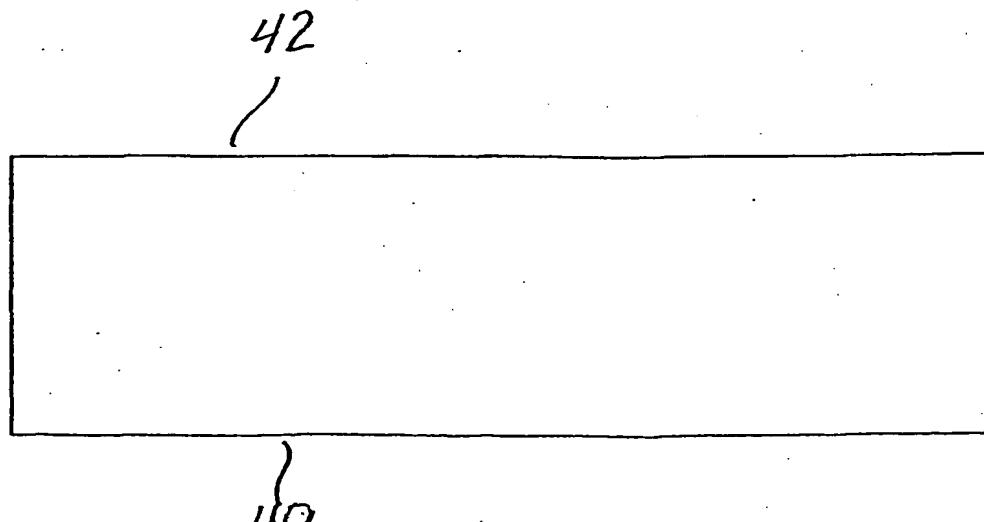
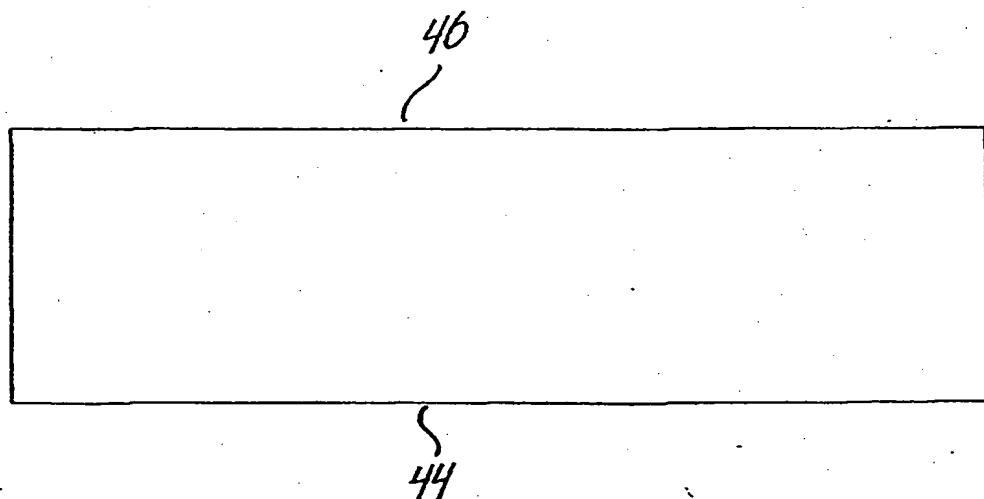
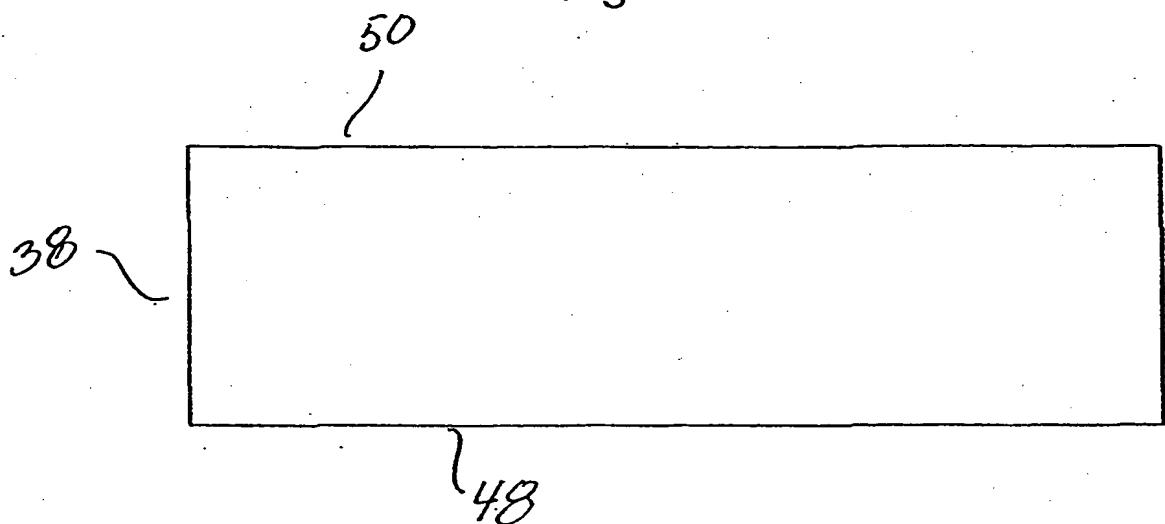
Fig. 6

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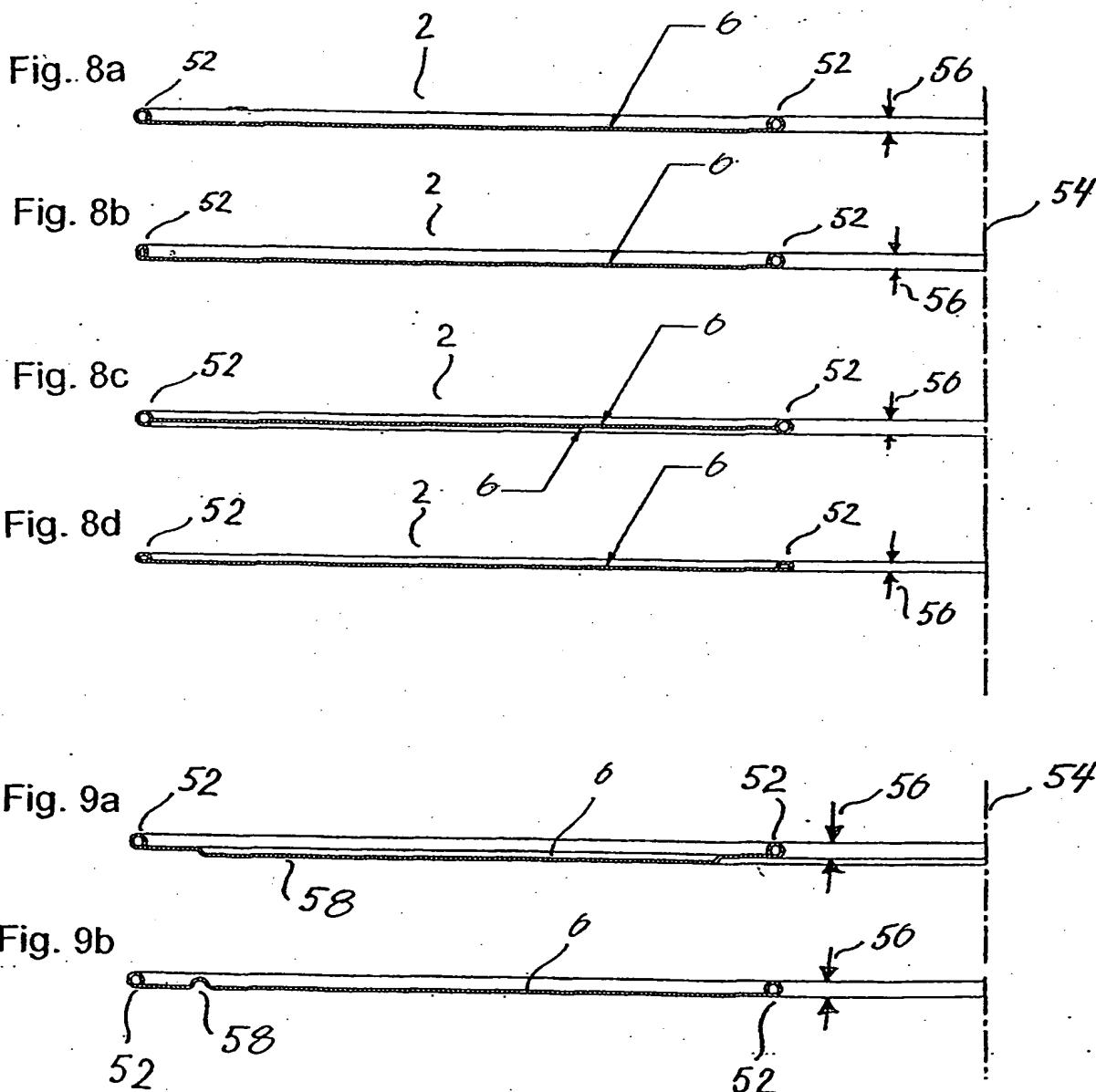
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Fig. 7



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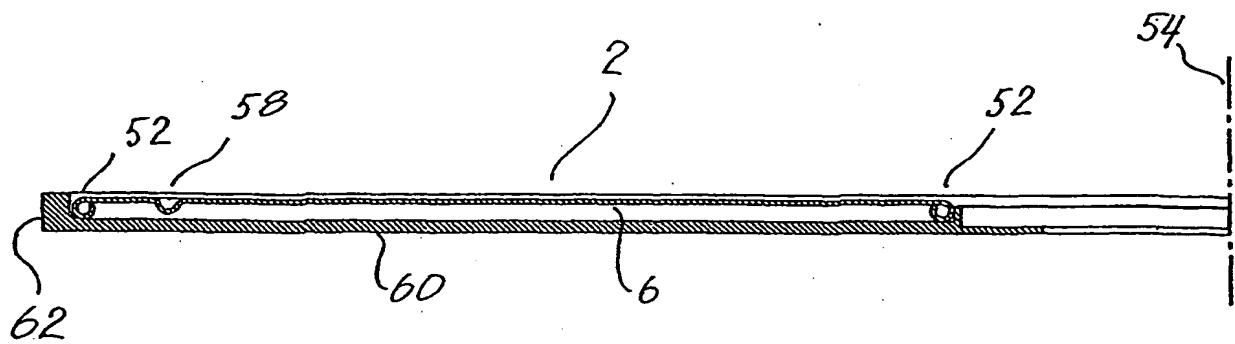


Fig. 10a

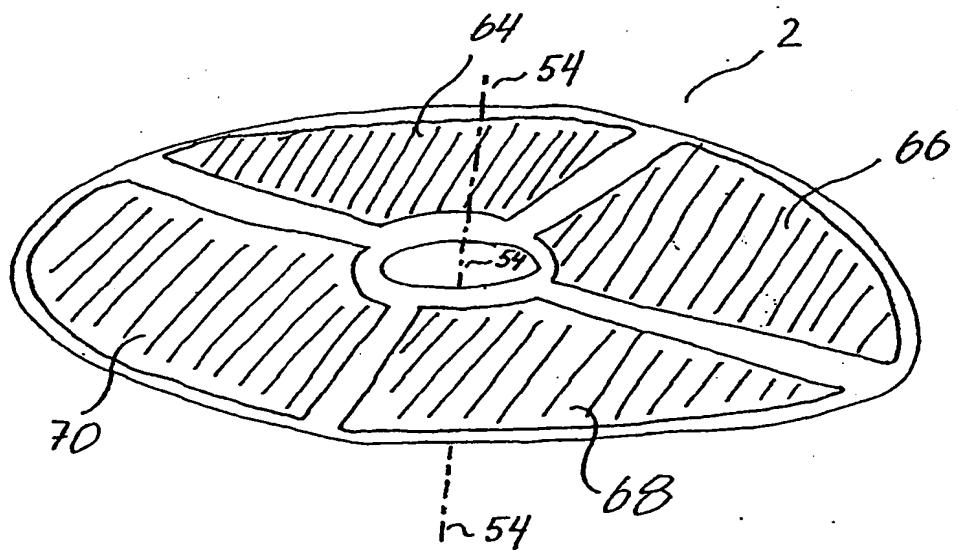


Fig. 11

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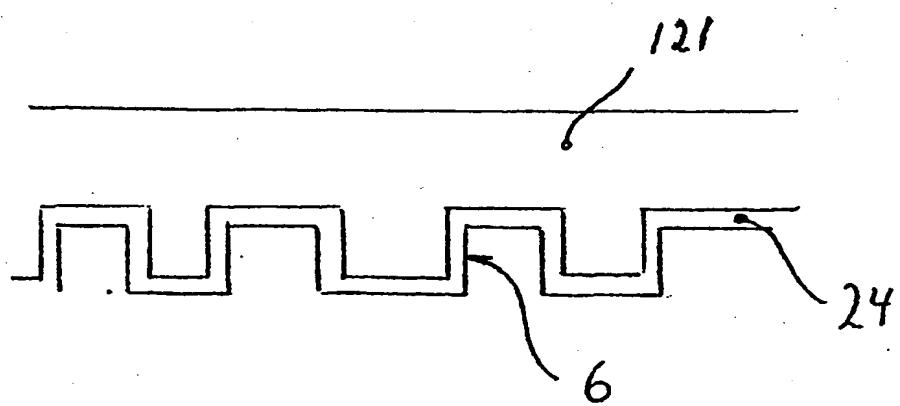


Fig. 12

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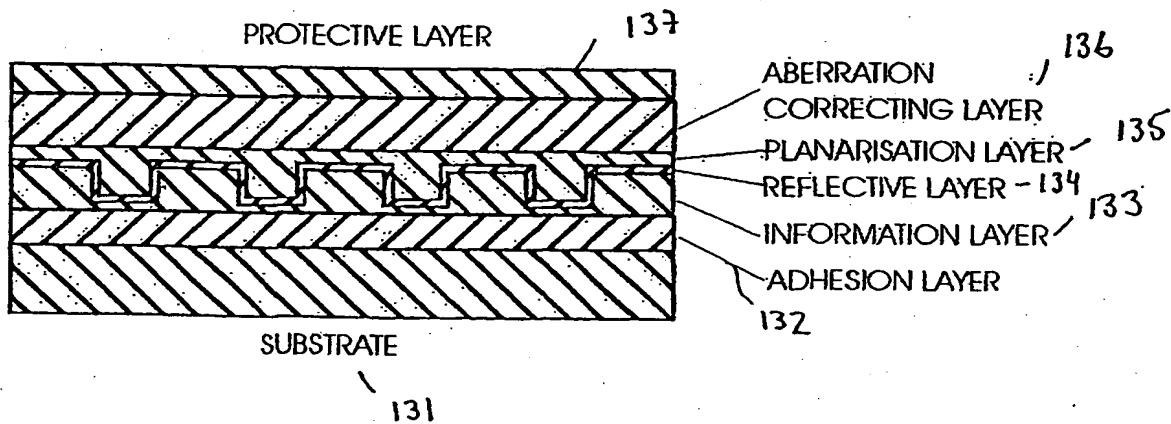


Fig. 13

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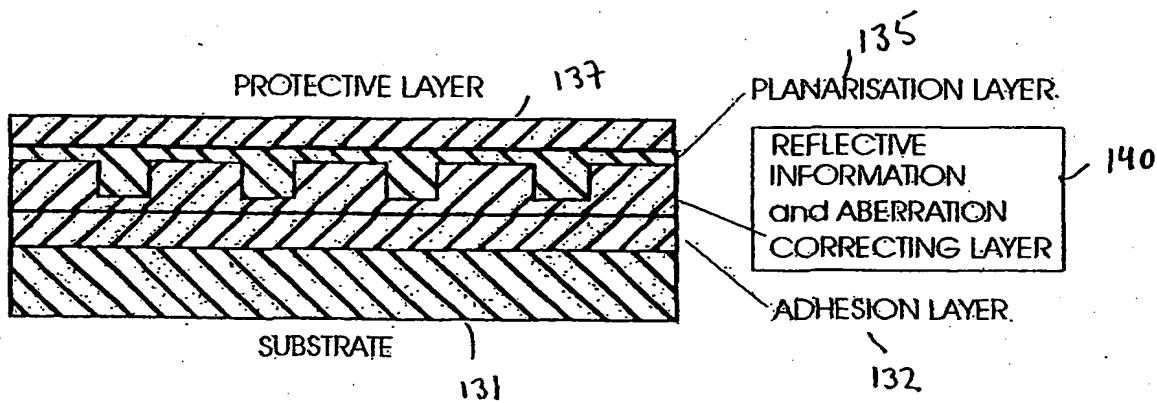


Fig. 14

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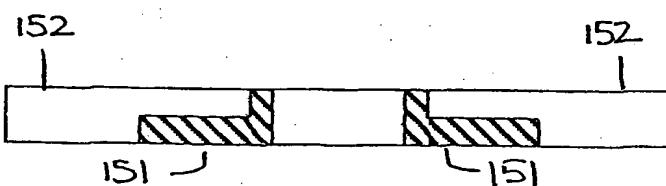


FIG. 15b

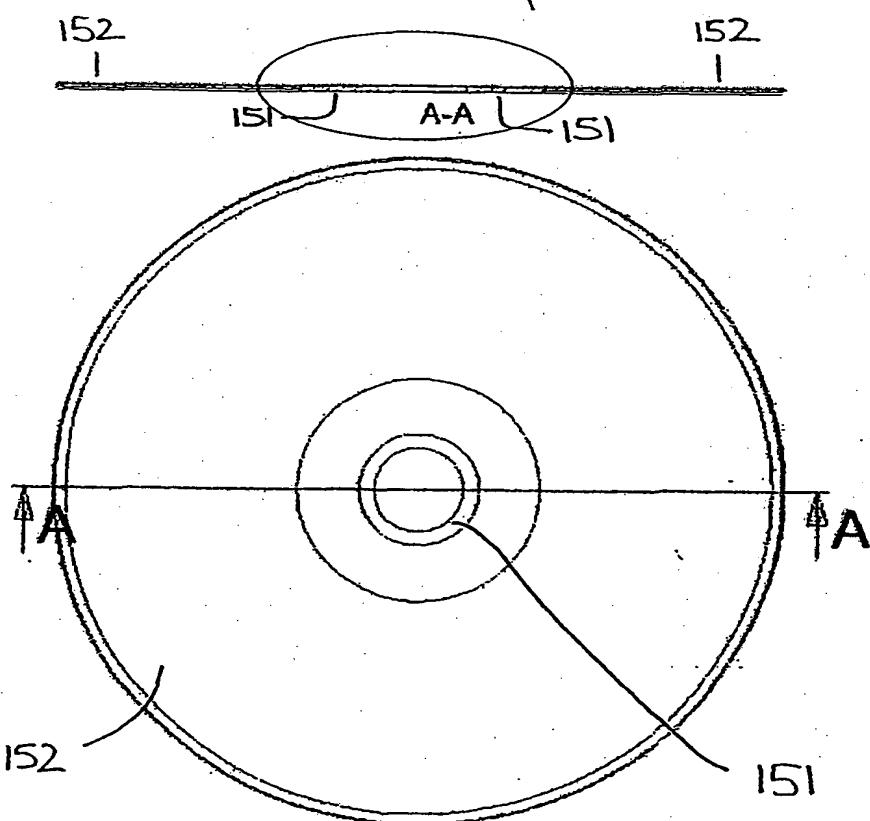


FIG. 15a